REMARKS

The subject application is a continuation of application no. 10/401,405, filed March 27, 2003. The specification has been amended to include appropriate priority information. Claims 1-6 have been cancelled without prejudice and claims 7-52 are new. No new matter has been added. Thus, after entry of the present amendment, claims 7-52 will be pending in the instant Application.

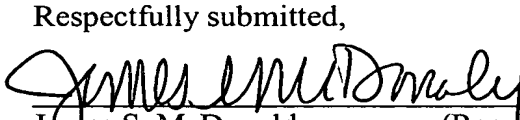
Support for the independent claims is referenced to Published Application No. 2003/0176068. Support for new claim 7 is found, for example, at paragraph [0124]. Support for new claim 30 is found, for example, at paragraph [0084]. Support for new claim 35 is found, for example, at paragraph [0114]. Support for claim 47 is found, for example, at paragraph [0120].

Certain features in selected claims are apparent in the specification such that one of skill in the art would understand that the element is disclosed therein. Support for new claim 24 is found, for example, at paragraph [0086], since 0.1M hydroxylamine salts contain, by definition, 0.1M hydroxylamine. Support for claim 48 is found, for example, at paragraph [0160], since the teaching provides the wafer size, the amount of polishing fluid, and the polishing rate in angstroms per minute. Claim 48 merely recites the understood property that the slurry was removing about 56 ppm to about 71 ppm of copper (in one form or another) in order to obtain that removal rate with the amount of slurry used. Support for claim 49 is found, for example, at paragraphs [0151]-[0152], which discloses a hydroxylamine nitrate solution with added hydroxylamine to obtain pH's of 3, 4 and 5. One of skill in the art would know that for the amounts of hydroxylamine nitrate taught, the amounts of hydroxylamine necessary to obtain the target pH's are as follows: no hydroxylamine results in a pH of 2.72; 0.005% hydroxylamine results in a pH of 3; 0.04% hydroxylamine results in a pH of 4; and 0.36% hydroxylamine results in a pH of 5.

Entry of the above amendments and remarks are respectfully requested.

Respectfully submitted,

Date: October 10, 2003



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